

REV.	ECN. NO.	APPD.
A	BC-07-7073812	JOHN CHOW

1. MATERIAL
HOUSING: THERMOPLASTIC, BLACK, UL 94V-0.
CONTACT: PHOSPHOR BRONZE.
2. PLATING:
50u" MIN. NICKEL UNDERPLATING OVER ALL.
150u" MIN. TIN/LEAD OR LEAD FREE (SATIN TIN)
PLATING AT TAIL AREA.
GOLD PLATING AT MATING AREA.
3. DESIGNED TO CONFORM WITH SFP+ MSA SPECIFICATION.

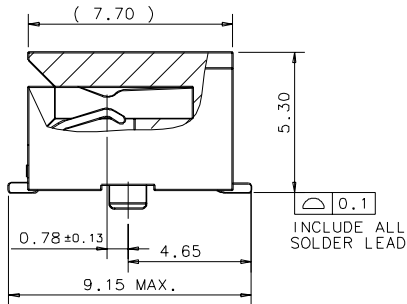
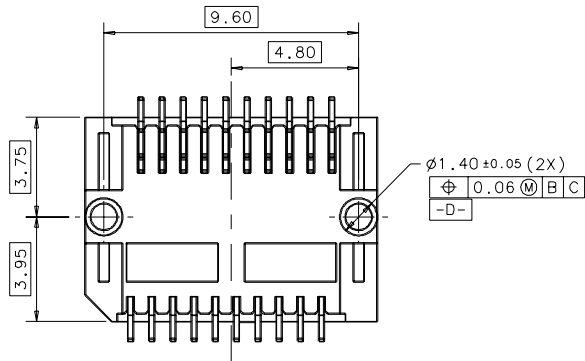
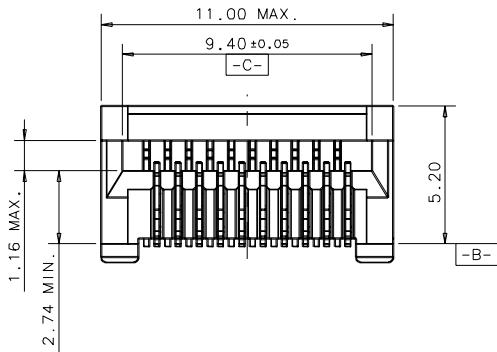
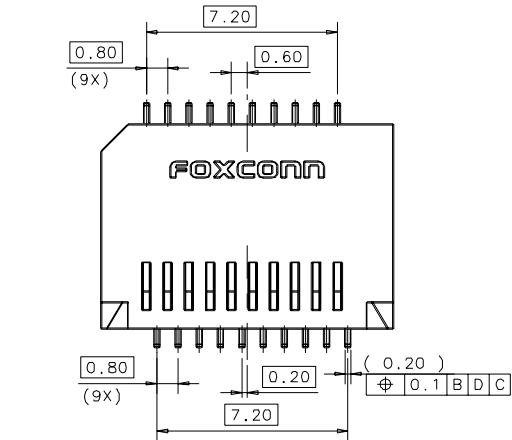
3S1020C*-011-

CONTACT PLATING

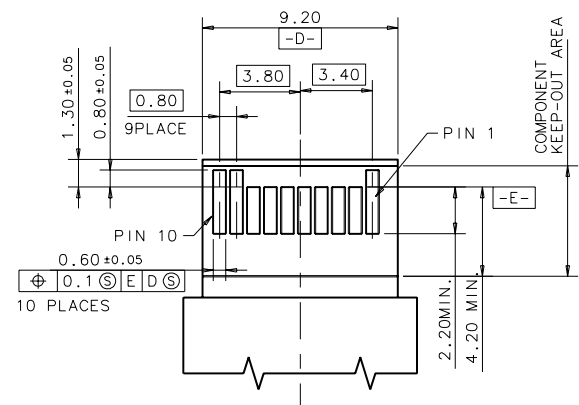
3:	30u "	GOLD
5:	50u "	GOLD
7:	15u "	GOLD

- LEAD FREE CODE
F: LEAD FREE CODE,
ROHS LEVEL 6 COMPLIANCE
NONE: TIN/LEAD,
ROHS LEVEL 5 COMPLIANCE

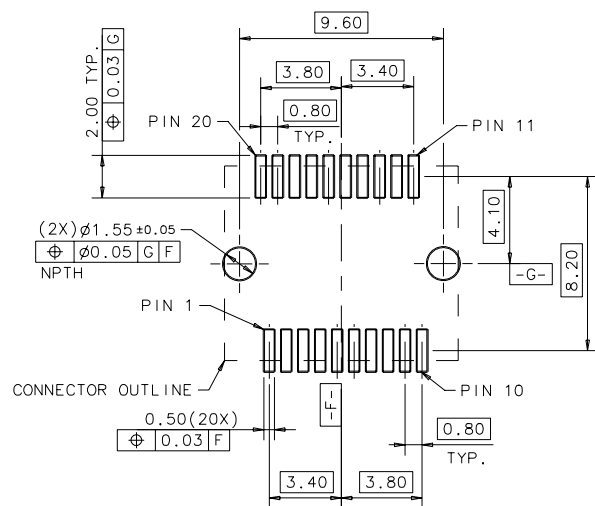
-PACKAGE CODE
7: TAPE AND REEL

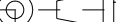


X. ±	X.° ± 5.°	UNITS mm	NAME (INTENDED USE)	FOXCONN		
X ± 0.20	X.° ± 3.°	MAT'L	SFP+ 20POS STANDARD TYPE	HON HAI PRECISION IND. CO.,LTD. TAIPEI, TAIWAN, R.O.C.		
XX ± 0.15	.XX° ±	SEE NOTES	PART NO. (INTENDED USE)	TITLE:		
XXX ±	.XXX° ±	FINISH	3S1020C3-011-**-	CUSTOMER DRAWING		
THESE DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF HON HAI PRECISION IND. CO., LTD. AND SHALL NOT BE REPRODUCED, COPIED OR USED IN ANY MANNER WITHOUT THE PRIOR WRITTEN CONSENT OF HON HAI PRECISION IND. CO., LTD.	SEE NOTES	APPD:JOHN CHOW 11/6'07	DWG NO.:			
			323-0000-1442			
		Q'TY	CHKD:PIER HSU 11/6'07		SCALE	SHEET
	DR:DAVID ZHANG 11/6'07	N/A	1/2		A	



BOTTOM VIEW OF BOARD



X. ±	X. ° ± 5. °	UNITS mm	NAME (INTENDED USE)	FOXCONN		
.X ± 0.25	.X ° ± 3. °	MAT'L	SFP+ 20POS STANDARD TYPE	HON HAI PRECISION IND. CO.,LTD. TAIPEI, TAIWAN, R.O.C.		
.XX ± 0.15	.XX ° ±	SEE NOTES	PART NO. (INTENDED USE)	TITLE:		
.XXX ±	.XXX ° ±	FINISH	3S1020C3-011-**	CUSTOMER DRAWING		
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		Q'TY	CHKD:PIER HSU 11/6'07	323-0000-SFP+		
			DR:DAVID ZHANG 11/6'07		SCALE	SHEET
				N/A	2/2	A